



# Product Change Notification

**Change Notification #:** 115503 - 00  
**Change Title:** Intel® Ethernet QSFP+ LR Optics  
Product Code E40GQSFPLR MM#933912

Intel® Ethernet SFP+ SR Optics  
Product Code E10GSFPSR MM#903239

Intel® Ethernet SFP+ LR OPTICS  
Product Code E10GSFPLR MM#903240

Intel® Ethernet QSFP+ SR Optics  
Product Code E40GQSFPSR MM#933911

Intel® Ethernet SFP+ SR OPTICS  
Product Code E10GSFPSRG1P5  
MM#909923,

PCN 115503-00, Label, Documentation

Label Update to remove KCC and Flyer  
update for E40GQSFPLR

**Date of Publication:** May 04, 2017

## Key Characteristics of the Change:

Label, Documentation

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 28, 2017
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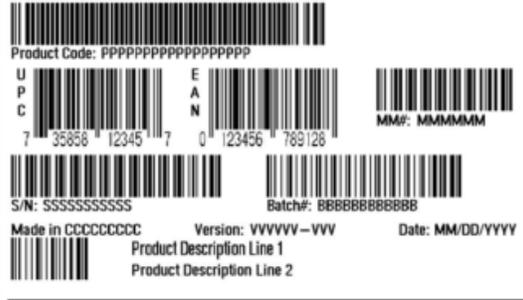
## Description of Change to the Customer:

The Intel products listed below will undergo the following changes:

Product Code	MM#	Marketing Name
E40GQSFPLR	933912	Intel® Ethernet QSFP+ LR Optics
E10GSFPSR	903239	Intel® Ethernet SFP+ SR Optics
E10GSFPLR	903240	Intel® Ethernet SFP+ LR OPTICS
E40GQSFPSR	933911	Intel® Ethernet QSFP+ SR Optics
E10GSFPSRG1P5	909923	Intel® Ethernet SFP+ SR OPTICS

1. Due to regulatory updates the KCC logo is not required on optic SKUs. This change will affect the Outer Box Label (OBL) and distribution label.

Outer box label example before and after:



**IF SEAL IS BROKEN, THE UNIT CANNOT BE RETURNED  
UNLESS THE UNIT IS DEFECTIVE AND ELIGIBLE FOR  
WARRANTY SERVICE**

For CE Mark--Related Questions:  
Intel Corporation  
Attn: Corporate Quality  
2200 Mission College Blvd.  
Santa Clara, CA 95054-1549  
USA



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USA





## Before



关于符合中国《电子信息产品污染控制管理办法》  
的声明



H46535-001

**Management Methods on Control of Pollution  
from Electronic Information Products (China RoHS declaration)**  
产品中有毒有害物质的名称及含量

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
印刷板组件	×	○	○	○	○	○

○：表示该有毒有害物质在该部件所有均质材料中的含量均在 GB/T 26572 标准规定的限量要求以下。

○：Indicates that this hazardous substance contained in all homogeneous materials of such component is within the limits specified in GB/T 26572.

×：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 GB/T 26572 标准规定的限量要求。

×：Indicates that the content of such hazardous substance in at least a homogeneous material of such component exceeds the limits specified in GB/T 26572.

对销售之日的所售产品，本表显示我公司供应链的电子信息产品可能包含这些物质。注意：在所售产品中可能会也可能不会含有所有所列的部件。

This table shows where these substances may be found in the supply chain of our electronic information products, as of the date of sale of the enclosed product. Note that some of the component types listed above may or may not be a part of the enclosed product.

For regulatory information go to the user guide:

<http://support.intel.com/support/network/adapter/pro100/sb/CS-034787.htm>

For CE Mark-Related Questions:  
Intel Corporation, Attn: Corporate Quality  
2200 Mission College Blvd  
Santa Clara, CA 95054-1549, USA



## After



关于符合中国《电子信息产品污染控制管理办法》的声明  
Management Methods on Control of Pollution

from Electronic Information Products (China RoHS declaration)  
产品中有毒有害物质的名称及含量

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
印刷板组件	×	○	○	○	○	○

○：表示该有毒有害物质在该部件所有均质材料中的含量均在 GB/T 26572 标准规定的限量要求以下

○：Indicates that this hazardous substance contained in all homogeneous materials of such component is within the limits specified in GB/T 26572

×：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 GB/T 26572 标准规定的限量要求

×：Indicates that the content of such hazardous substance in at least a homogeneous material of such component exceeds the limits specified in GB/T 26572

除非另外特别的标注，此标志为针对所涉及产品的环保使用期限标志。某些可更换的零部件可能会有一个不同的环保使用期限（例如，电池单元模块）。

此环保使用期限只适用于产品在产品手册中所规定的条件下工作。



The Environmental Protection Use Period (EPUP) for all enclosed products and their parts are per the symbol shown here, unless otherwise marked. Certain field-replaceable parts may have a different EPUP (for example, battery modules) number. The Environment-Friendly Use Period is valid only when the product is operated under the conditions defined in the product manual.



H64661-001

3. On all the products the TA (Top Assembly) number will roll as noted in the affected products table within this PCN notice. If the TA number is printed on any product or box label, those will show the dash roll as well.

### **Customer Impact of Change and Recommended Action:**

Intel anticipates no impact to customers.

Customers can expect to receive mixed inventory.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

### **Products Affected / Intel Ordering Codes:**

<b>Product Code</b>	<b>MM#</b>	<b>Pre Change TA</b>	<b>Post Change TA</b>
E10GSFPSR	903239	E70293-007	E70293-008
E10GSFPLR	903240	E70292-006	E70292-007
E10GSFPSRG1P5	909923	G17046-005	G17046-006
E40GQSFPSR	933911	G67930-003	G67930-004
E40GQSFPLR	933912	J21336-001	J21336-002

### **PCN Revision History:**

**Date of Revision:**

May 4, 2017

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 115503 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apagccb@intel.com](mailto:apagccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

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